

18N65-MH Preliminary Power MOSFET

18A, 650V N-CHANNEL POWER MOSFET

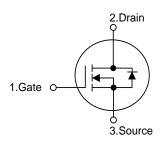
■ DESCRIPTION

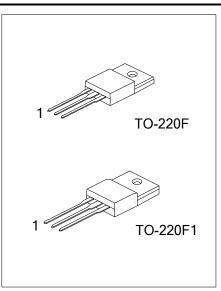
The UTC **18N65-MH** is a high voltage power MOSFET combines advanced trench MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

■ FEATURES

- * $R_{DS(ON)} \le 0.45 \Omega$ @ $V_{GS}=10V$, $I_D=9.0A$
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

■ SYMBOL

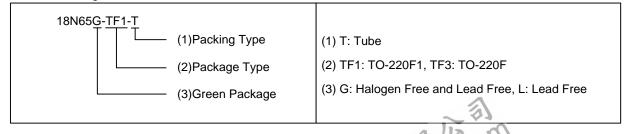




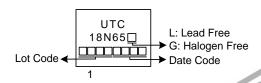
■ ORDERING INFORMATION

	Ordering Number		Daakaaa	Pin Assignment			Daakina
	Lead Free	Halogen Free	Package	1	2	3	Packing
	18N65L-TF1-T	18N65G-TF1-T	TO-220F1	G	D	S	Tube
	18N65L-TF3-T	18N65G-TF3-T	TO-220F	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source



■ MARKING



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■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT		
Drain-Source Voltage	V_{DSS}	650	V		
Gate-Source Voltage	V_{GSS}	±30	V		
Continuous Drain Current	I_{D}	18	Α		
Pulsed Drain Current (Note 2)		I _{DM}	36	Α	
Avalanche Energy Single	Pulsed (Note 3)	E _{AS}	1058	mJ	
Peak Diode Recovery dv/dt (Note 4) Power Dissipation Junction Temperature Storage Temperature		dv/dt	2.46	V/ns	
		P_D	42	W	
		TJ	+150	°C	
		T _{STG}	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 30mH, I_{AS} = 8.4A, V_{DD} = 100V, R_G = 25 Ω , Starting T_J = 25°C
- 4. $I_{SD} \le 9.0 A$, di/dt $\le 200 A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25 ^{\circ}C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATING	UNIT	
Junction to Ambient	θ_{JA}	62.5	°C/W	
Junction to Case	θ_{JC}	2.98	°C/W	

■ **ELECTRICAL CHARACTERISTICS** (T_J=25°C, unless otherwise specified)

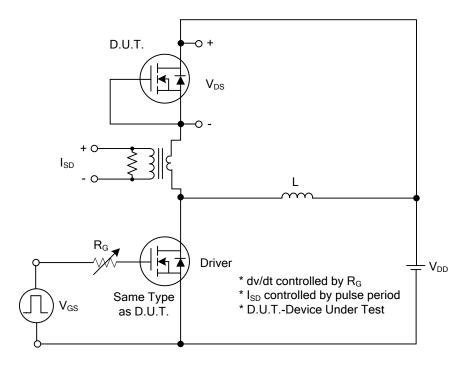
DADAMETED		CVMDOL	TECT CONDITIONS	NAINI	TVD	NAAV	LINIT		
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	WAX	UNIT		
OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS}=0V$, $I_D=250\mu A$	650			V		
Drain-Source Leakage Current		I _{DSS}	V_{DS} =650V, V_{GS} =0V			10	μΑ		
ate- Source Leakage Current	Forward	I _{GSS}	$V_{GS}=30V$, $V_{DS}=0V$			100	nA		
	Reverse		V_{GS} =-30V, V_{DS} =0V			-100	nA		
ON CHARACTERISTICS									
Gate Threshold Voltage	Gate Threshold Voltage		$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.0		4.0	V		
Static Drain-Source On-State Resistance		V _{GS(TH)} R _{DS(ON)}	V _{GS} =10V, I _D =9.0A			0.45	Ω		
DYNAMIC CHARACTERISTICS									
Input Capacitance		C _{ISS}			3195		pF		
Output Capacitance Reverse Transfer Capacitance		Coss	V _{DS} =25V, V _{GS} =0V, f=1.0MHz		262		pF		
		C _{RSS}			12		pF		
SWITCHING CHARACTERISTICS	S								
Total Gate Charge (Note 1)	I Gate Charge (Note 1)		V _{DS} =520V, V _{GS} =10V, I _D =18A		62.8		nC		
Gate-Source Charge Gate-Drain Charge		Q_{GS}	$I_{G}=1$ mA (Note 1, 2)		15		nC		
		Q_{GD}	IG-TITIA (Note 1, 2)		14.5		nC		
Turn-On Delay Time (Note 1)	urn-On Delay Time (Note 1)				44		ns		
Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time		t _R	V _{DS} =100V, V _{GS} =10V, I _D =18A,		22		ns		
		t _{D(OFF)}	R _G =25Ω (Note 1, 2)		170		ns		
		t _F			43		ns		
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS									
Maximum Body-Diode Continuous	Current	Is	10, V	4		18	Α		
Maximum Body-Diode Pulsed Cur	aximum Body-Diode Pulsed Current		K PV a CO			36	Α		
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	$I_S=18A$, $V_{GS}=0V$			1.4	V		
Reverse Recovery Time (Note 1)	covery Time (Note 1) t _{rr} l _s =18A , V _{GS} =0V		Is=18A , V _{GS} =0V		490		ns		
Reverse Recovery Charge		Qm	di/dt=100A/µs		18.2		μC		

Notes: 1. Pulse Test: Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

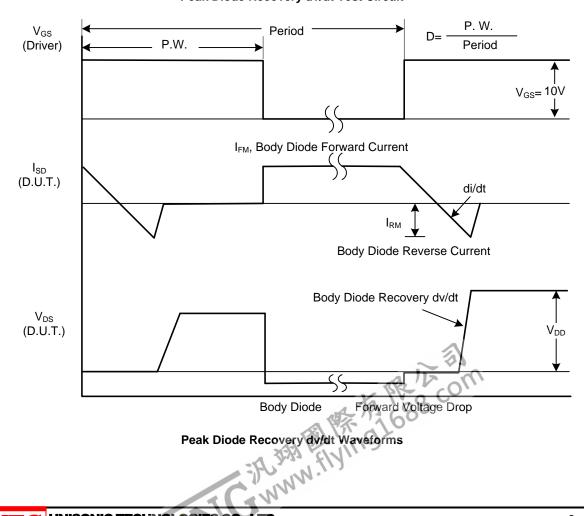
2. Essentially independent of operating temperature.



TEST CIRCUITS AND WAVEFORMS

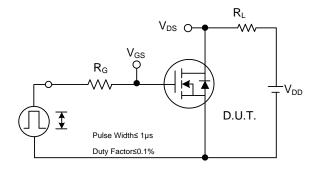


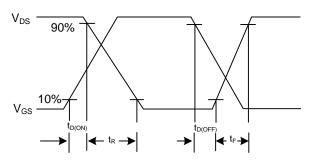
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

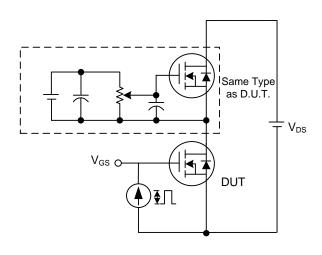
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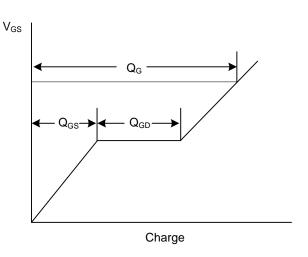




Switching Test Circuit

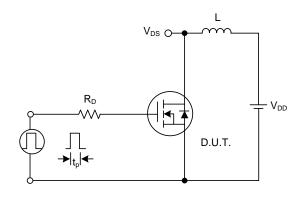
Switching Waveforms

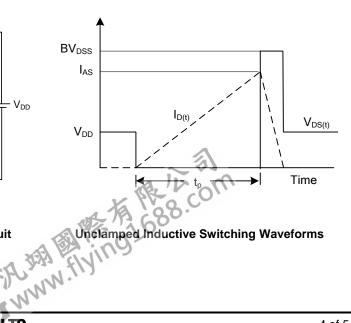




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

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